

v04.0109

GaAs HBT MMIC DIVIDE-BY-4, DC - 11 GHz

Typical Applications

Prescaler for DC to X Band PLL Applications:

- Satellite Communication Systems
- Fiber Optic
- Point-to-Point and Point-to-Multi-Point Radios
- VSAT

Features

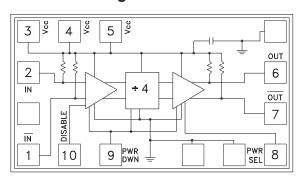
Ultra Low SSB Phase Noise: -149 dBc/Hz

Wide Bandwidth

Output Power: -6 dBm Single DC Supply: +5V

Small Size: 1.30 x 0.69 x 0.1 mm

Functional Diagram



General Description

The HMC362 is a low noise Divide-by-4 Static Divider with InGaP GaAs HBT technology that has a small size of 1.30 x 0.69 mm. This device operates from DC (with a square wave input) to 11 GHz input frequency with a single +5V DC supply. The low additive SSB phase noise of -149 dBc/Hz at 100 kHz offset helps the user maintain good system noise performance.

Electrical Specifications, $T_A = +25^{\circ}$ C, 50 Ohm System, Vcc= 5V

Parameter	Conditions	Min.	Тур.	Max.	Units
Maximum Input Frequency		11	12		GHz
Minimum Input Frequency	Sine Wave Input. [1]		0.2	0.5	GHz
Input Power Range	Fin = 1 to 8 GHz	-15	>-20	+10	dBm
	Fin = 8 to 11 GHz	-10	>-15	+2	dBm
Output Power [2]	Fin = 11 GHz	-9	-6		dBm
Reverse Leakage	Both RF Outputs Terminated		40		dB
SSB Phase Noise (100 kHz offset)	Pin = 0 dBm, Fin = 6 GHz		-149		dBc/Hz
Output Transition Time	Pin = 0 dBm, Fout = 882 MHz		100		ps
Supply Current (Icc) [2]			68		mA

^[1] Divider will operate down to DC for square-wave input signal.

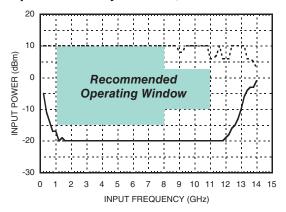
^[2] When operated in low power mode (pin 8 floating).



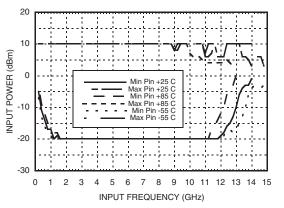
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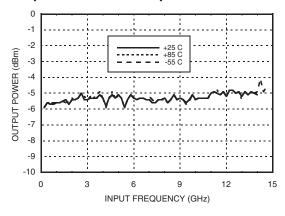
Input Sensitivity Window, T= 25 °C



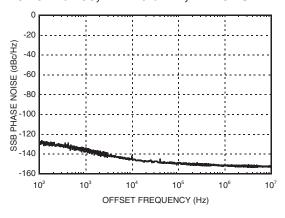
Input Sensitivity Window vs. Temperature



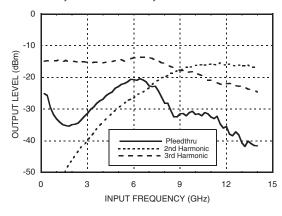
Output Power vs. Temperature



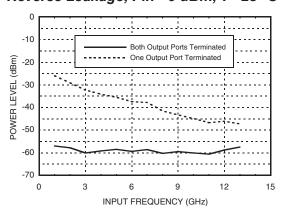
SSB Phase Noise Performance, Pin= 0 dBm, T= 25 °C



Output Harmonic Content, Pin= 0 dBm, T= 25 °C



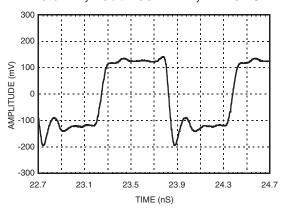
Reverse Leakage, Pin= 0 dBm, T= 25 °C





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Output Voltage Waveform, Pin= 0 dBm, Fout= 882 MHz, T= 25 °C



Absolute Maximum Ratings

RF Input (Vcc = +5V)	+13 dBm
Vcc	+5.5V
VLogic	Vcc -1.6V to Vcc -1.2V
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C



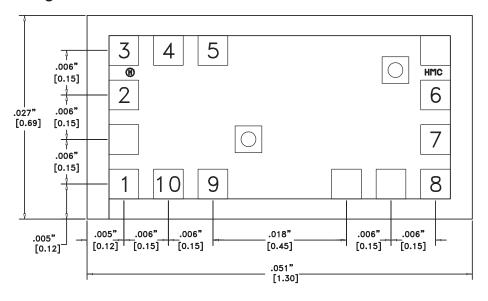
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)	
4.75	61	
5.0	68	
5.25	74	

Note: Divider will operate over full voltage range shown above

Outline Drawing



Die Packaging Information [1]

Standard	Alternate	
WP-8 (Waffle Pack)	[2]	

[1] Refer to the "Packaging Information" section for die packaging dimensions.

[2] For alternate packaging information contact Hittite Microwave Corporation.

NOTES:

- 1. ALL DIMENSIONS IN INCHES (MILLIMETERS)
- 2. ALL TOLERANCES ARE ±0.001 (0.025)
- 3. DIE THICKNESS IS 0.004 (0.100) BACKSIDE IS GROUND
- 4. BOND PADS ARE 0.004 (0.100) SQUARE
- 5. BOND PAD SPACING, CTR-CTR: 0.006 (0.150)
- 6. BACKSIDE METALLIZATION: GOLD
- 7. BOND PAD METALLIZATION: GOLD

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Pad Description

Pad Number	Function	Description	Interface Schematic
1	ĪN	RF Input 180° out of phase with pad 3 for differential operation. AC ground for single ended operation.	50 5V
2	IN	RF Input must be DC blocked.	50 SV
3, 4, 5	Vcc	Supply Voltage 5V ± 0.25 V can be applied to pad 3, 4, or 5.	5V 25
6	OUT	Divided Output	OUT
7	OUT	Divided output 180° out of phase with OUT.	5V OUT
8	PWR SEL	In the low power mode, the power select pin is left floating. By grounding this pin, the output power is increased by approximately 10 dB.	PWR
9	PWR DWN	The power down pin is grounded for normal operation. Applying 5 volts to this pin will power down this device.	PWR
10	DISABLE	The disable pin is grounded for normal operation. Applying 5 volts to this pin will disable the input buffer amplifier.	DISABLE

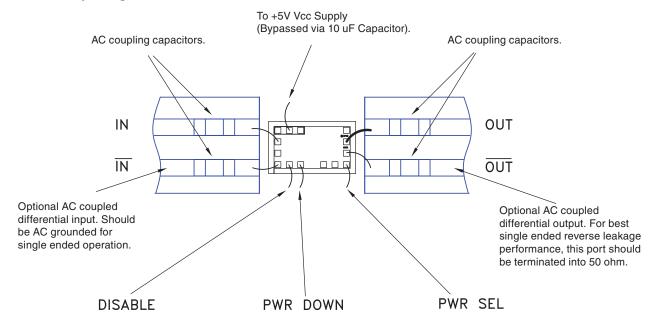


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Truth Table

Function	Pin	5V	GND	Float
DISABLE	10	Output Off	Output On	Х
PWR DWN	9	Power Down	Power Up	Х
PWR SEL	8	х	High Power Output	Low Power Output
X = State not permitted.				

Assembly Diagram



This port should be grounded for normal operation. Applying +5V to this port will disable the input buffer amplifier.

This port should be grounded for normal operation. Applying +5V to this port will power down the device.

For high power output, this port should be bonded to ground. For low power output, this port should be floating.